

TRIACs, 4A

Snubberless, Logic Level and Standard

MAIN FEATURES

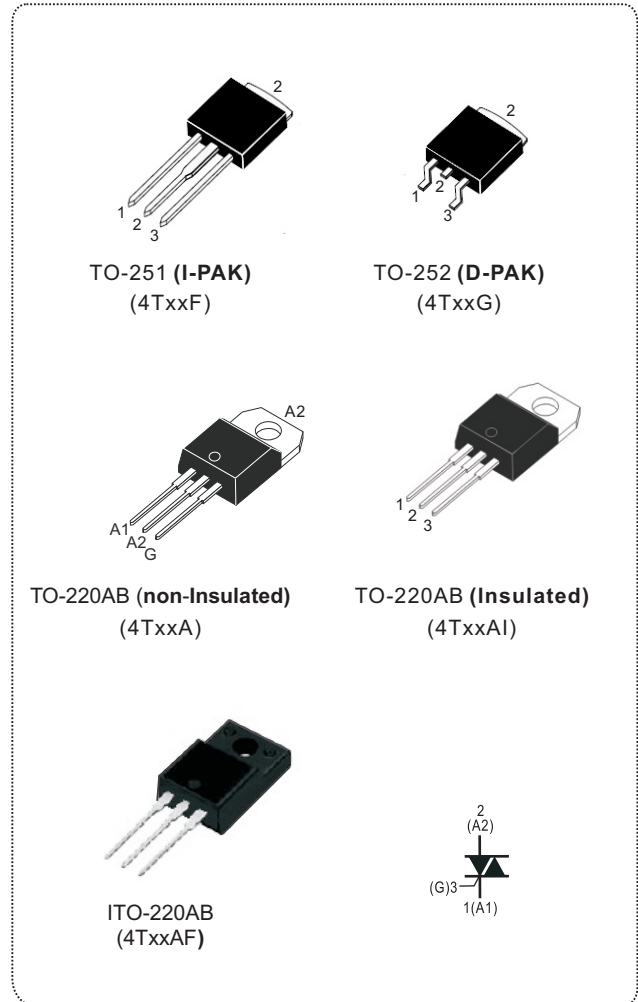
| SYMBOL | VALUE | UNIT |
|-------------------|-------------|------|
| $I_{T(RMS)}$ | 4 | A |
| V_{DRM}/V_{RRM} | 600 to 1000 | V |
| $I_{GT(Q1)}$ | 5 to 50 | mA |

DESCRIPTION

The 4T triac series is suitable for general purpose AC switching. They can be used as an ON/OFF function in applications such as static relays, heating regulation, induction motor starting circuits... or for phase control operation in light dimmers, motor speed controllers,...

The snubberless and logic level versions are specially recommended for use on inductive loads, thanks to their high commutation performances.

By using an internal ceramic pad, the 4T series provides voltage insulated tab (rated at 2500VRMS) complying with UL standards (File ref. :E320098)



| ABSOLUTE MAXIMUM RATINGS | | | | | |
|--|--------------|---------------------------|---------------------------|---------------|------------------------|
| PARAMETER | SYMBOL | TEST CONDITIONS | | VALUE | UNIT |
| RMS on-state current (full sine wave) | $I_{T(RMS)}$ | TO-251/TO-252/TO-220AB | $T_c = 105^\circ\text{C}$ | 4 | A |
| | | TO-220AB insulated | $T_c = 100^\circ\text{C}$ | | |
| Non repetitive surge peak on-state current (full cycle, T_j initial = 25°C) | I_{TSM} | F = 50 Hz | t = 20 ms | 35 | A |
| | | F = 60 Hz | t = 16.7 ms | 38 | |
| I^2t Value for fusing | I^2t | $t_p = 10$ ms | | 6 | A^2s |
| Critical rate of rise of on-state current $I_G = 2 \times I_{GT}$, $t_r \leq 100\text{ns}$ | dI/dt | F = 100 Hz | $T_j = 125^\circ\text{C}$ | 50 | $\text{A}/\mu\text{s}$ |
| Peak gate current | I_{GM} | $T_p = 20 \mu\text{s}$ | $T_j = 125^\circ\text{C}$ | 4 | A |
| Average gate power dissipation | $P_{G(AV)}$ | $T_j = 125^\circ\text{C}$ | | 1 | W |
| Storage temperature range | T_{stg} | | | - 40 to + 150 | °C |
| Operating junction temperature range | T_j | | | - 40 to + 125 | |

◎ ELECTRICAL CHARACTERISTICS (T_J= 25 °C unless otherwise specified)

| SNUBBERLESS and Logic level (3 quadrants) | | | | | | | |
|---|--|--------------|------|--------|-----|-----|------|
| SYMBOL | TEST CONDITIONS | QUADRANT | | 4Txxxx | | | Unit |
| | | | | TW | SW | CW | |
| I _{GT} ⁽¹⁾ | V _D = 12 V, R _L = 30Ω | I - II - III | MAX. | 05 | 10 | 35 | mA |
| V _{GT} | | I - II - III | MAX. | 1.3 | | | V |
| V _{GD} | V _D = V _{DRM} , R _L = 3.3KΩ T _j = 125°C | I - II - III | MIN. | 0.2 | | | V |
| I _H ⁽²⁾ | I _T = 200 mA | | MAX. | 10 | 15 | 35 | mA |
| I _L | I _G = 1.2 I _{GT} | I - III | MAX. | 10 | 25 | 50 | mA |
| | | II | | 15 | 30 | 60 | |
| dV/dt ⁽²⁾ | V _D = 67% V _{DRM} , gate open, T _j = 125°C | | MIN. | 20 | 40 | 400 | V/μs |
| (dl/dt) _c ⁽²⁾ | (dV/dt) _c = 0.1 V/μs T _j = 125°C | | MIN. | 1.8 | 2.7 | - | A/ms |
| | (dV/dt) _c = 10 V/μs T _j = 125°C | | | 0.9 | 2.0 | - | |
| | Without snubber T _j = 125°C | | | - | - | 2.5 | |

◎ ELECTRICAL CHARACTERISTICS (T_J= 25 °C unless otherwise specified)

| Standard (4 quadrants) | | | | | | | | |
|-------------------------------------|--|--------------|------|--------|----|----|----|------|
| SYMBOL | TEST CONDITIONS | QUADRANT | | 4Txxxx | | | | UNIT |
| | | | | T | D | S | A | |
| I _{GT} ⁽¹⁾ | V _D = 12 V, R _L = 30Ω | I - II - III | MAX. | 5 | 5 | 10 | 10 | mA |
| V _{GT} | | IV | | 5 | 10 | 10 | 25 | |
| V _{GD} | V _D = V _{DRM} , R _L = 3.3KΩ, T _j = 125°C | ALL | | 1.3 | | | | V |
| V _{GD} | V _D = V _{DRM} , R _L = 3.3KΩ, T _j = 125°C | ALL | | 0.2 | | | | V |
| I _H ⁽²⁾ | I _T = 200 mA | | MAX. | 5 | 10 | 10 | 25 | mA |
| I _L | I _G = 1.2 I _{GT} | I - III - IV | MAX. | 10 | 10 | 15 | 25 | mA |
| | | II | | 15 | 20 | 25 | 40 | |
| dV/dt ⁽²⁾ | V _D = 67% V _{DRM} , gate open, T _j = 125°C | | MIN. | 5 | 5 | 10 | 50 | V/μs |
| (dV/dt) _c ⁽²⁾ | (dl/dt) _c = 1.7 A/ms, T _j = 125°C | | MIN. | 0.5 | 1 | 2 | 5 | |

| STATIC CHARACTERISTICS | | | | |
|--------------------------------------|--|------------------------|-------|------|
| SYMBOL | TEST CONDITIONS | | VALUE | UNIT |
| V _{TM} ⁽²⁾ | I _{TM} = 5.5 A, t _p = 380 μs | T _j = 25°C | MAX. | 1.55 |
| V _{TO} ⁽²⁾ | Threshold voltage | | MAX. | 0.85 |
| R _D ⁽²⁾ | Dynamic resistance | | MAX. | 100 |
| I _{DRM} I _{RDM} | V _D = V _{DRM} V _R = V _{RDM} | T _j = 25°C | MAX. | 5 |
| | | T _j = 125°C | | 1 |

Note 1: Minimum I_{GT} is guaranteed at 5% of I_{GT} max.

Note 2: For both polarities of A2 referenced to A1.

| THERMAL RESISTANCE | | | | | |
|----------------------|-----------------------|--|---|-------|------|
| SYMBOL | | | | VALUE | UNIT |
| R _{th(j-c)} | Junction to case (AC) | | TO-220AB, TO-251, TO-252 | 2.6 | °C/W |
| | | | TO-220AB Insulated, ITO-220AB | 4.0 | |
| R _{th(j-a)} | Junction to ambient | | S = 0.5 cm ² TO-252 | 70 | °C/W |
| | | | TO-220AB Insulated, TO-220AB, ITO-220AB | 60 | |
| | | | TO-251 | 100 | |

S = Copper surface under tab.

| PRODUCT SELECTOR | | | | | | |
|--------------------|--------------|-------|--------|---------------|-------------|-----------------|
| PART NUMBER | VOLTAGE (xx) | | | SENSITIVITY | TYPE | PACKAGE |
| | 600 V | 800 V | 1000 V | | | |
| 4TxxA-CW/4TxxAI-CW | V | V | V | 35 mA | Snubberless | TO-220AB |
| 4TxxA-S/4TxxAI-S | V | V | V | 10 mA | Standard | TO-220AB |
| 4TxxA-A/4TxxAI-A | V | V | V | 10 mA | Standard | TO-220AB |
| 4TxxA-SW/4TxxAI-SW | V | V | V | 10 mA | Logic level | TO-220AB |
| 4TxxA-T/4TxxAI-T | V | V | V | 5 mA | Standard | TO-220AB |
| 4TxxA-D/4TxxAI-D | V | V | V | 5 mA | Standard | TO-220AB |
| 4TxxA-TW/4TxxAI-TW | V | V | V | 5 mA | Logic level | TO-220AB |
| 4TxxF-CW | V | V | V | 35 mA | Snubberless | I-PAK |
| 4TxxG-CW | V | V | V | 35 mA | Snubberless | D-PAK |
| 4TxxF-SW | V | V | V | 10 mA | Logic level | I-PAK |
| 4TxxG-SW | V | V | V | 10 mA | Logic level | D-PAK |
| 4TxxF-TW | V | V | V | 5 mA | Logic level | I-PAK |
| 4TxxG-TW | V | V | V | 5 mA | Logic level | D-PAK |
| 4TxxF-T/D/S/A | V | V | V | 5 /5/10/10 mA | Standard | I-PAK |
| 4TxxG-T/D/S/A | V | V | V | 5 /5/10/10 mA | Standard | D-PAK |
| 4TxxAF-CW | V | V | V | 35 mA | Snubberless | ISOWAT TO-220AB |
| 4TxxAF-SW | V | V | V | 10 mA | Logic level | ISOWAT TO-220AB |
| 4TxxAF-TW | V | V | V | 5 mA | Logic level | ISOWAT TO-220AB |
| 4TxxAF-D | V | V | V | 5 mA | Standard | ISOWAT TO-220AB |
| 4TxxAF-A | V | V | V | 10 mA | Standard | ISOWAT TO-220AB |

| ORDERING INFORMATION | | | | | |
|----------------------|-----------|----------------------|--------|-----------|---------------|
| ORDERING TYPE | MARKING | PACKAGE | WEIGHT | BASE Q'TY | DELIVERY MODE |
| 4TxxA-yy | 4TxxA-yy | TO-220AB | 2.0g | 50 | Tube |
| 4TxxAI-yy | 4TxxAI-yy | TO-220AB (insulated) | 2.3g | 50 | Tube |
| 4TxxF-yy | 4TxxF-yy | TO-251(I-PAK) | 0.40g | 80 | Tube |
| 4TxxG-yy | 4TxxG-yy | TO-252(D-PAK) | 0.38g | 80 | Tube |
| 4TxxAF-yy | 4TxxAF-yy | ISOWAT TO-220AB | 2.5g | 50 | Tube |

Note: xx = voltage, yy = sensitivity

ORDERING INFORMATION SCHEME

4 T 06 A - CW

Current

4 = 4A

Triac series

Voltage

06 = 600V

08 = 800V

10 = 1000V

Package type

A = TO-220AB (non-insulated)

AI = TO-220AB (insulated)

AF = TO-220F (ISOWAT TO-220AB, insulated)

F = TO-251 (I-PAK)

G = TO-252 (D-PAK)

IGT Sensitivity

T = 5mA Standard

CW = 35mA Snubberless

D = 5mA Standard

TW = 5mA Logic Level

S = 10mA Standard

SW = 10mA Logic Level

A = 10mA Standard

Fig.1 Maximum power dissipation versus RMS on-state current (full cycle)

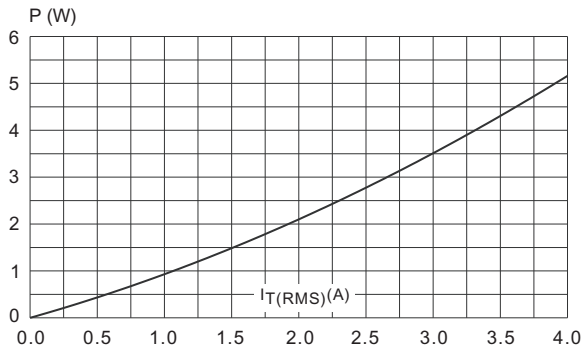


Fig.2 RMS on-state current versus case temperature (full cycle)

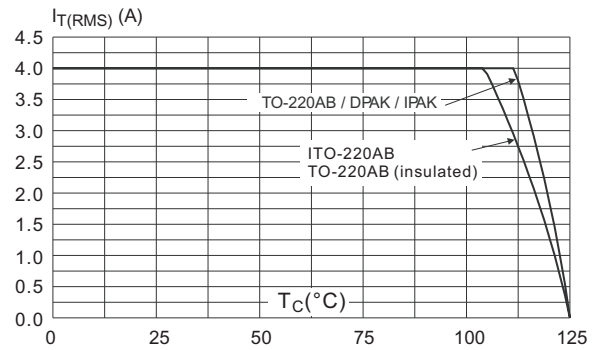


Fig.3 RMS on-state current versus ambient temperature (printed circuit board FR4, copper thickness: 35µm)(full cycle)

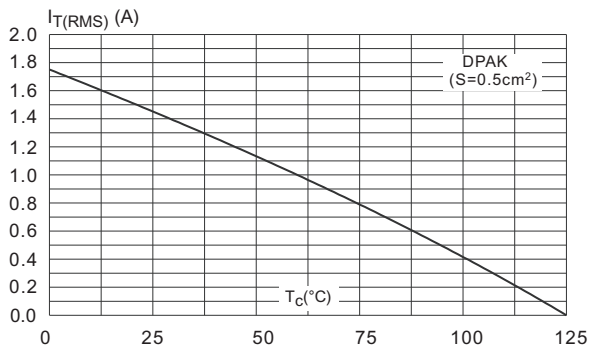


Fig.4 Relative variation of thermal impedance versus pulse duration.

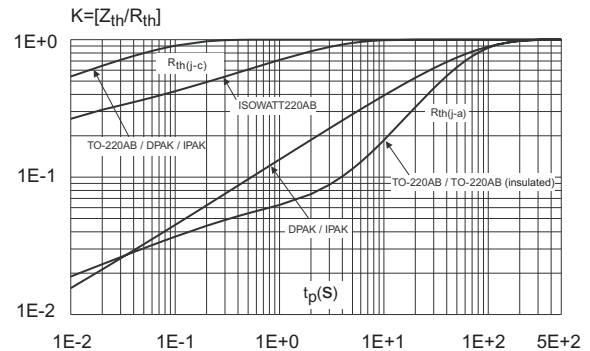


Fig.5 On-state characteristics (maximum values).

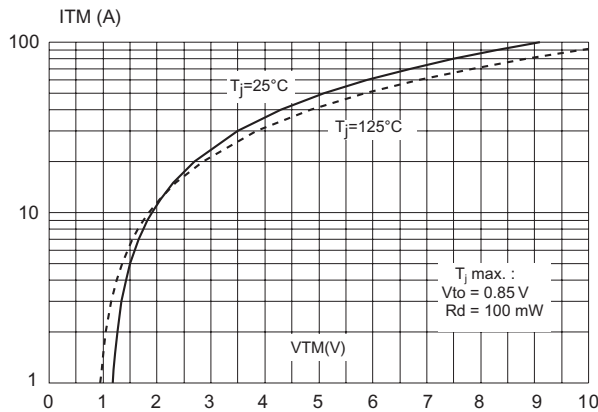


Fig.6 Surge peak on-state current versus number of cycles.

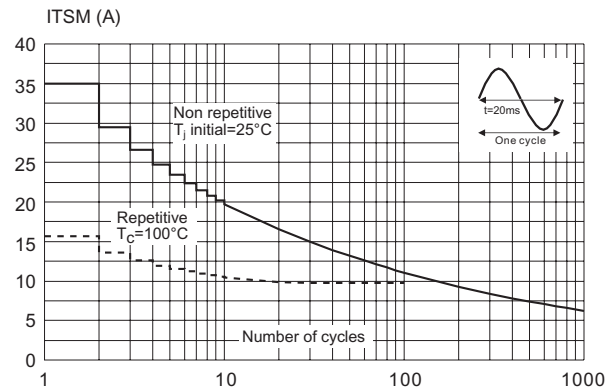


Fig.7 Non-repetitive surge peak on-state current for a sinusoidal pulse with width $t_p < 10 \text{ ms}$. and corresponding value of I^2t .

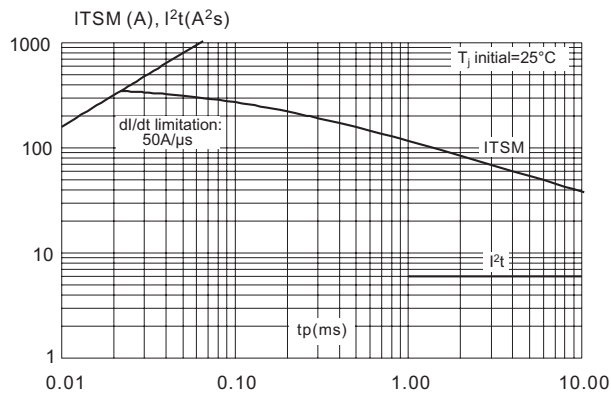


Fig.8 Relative variation of gate trigger current, holding current and latching current versus junction temperature (typical values).

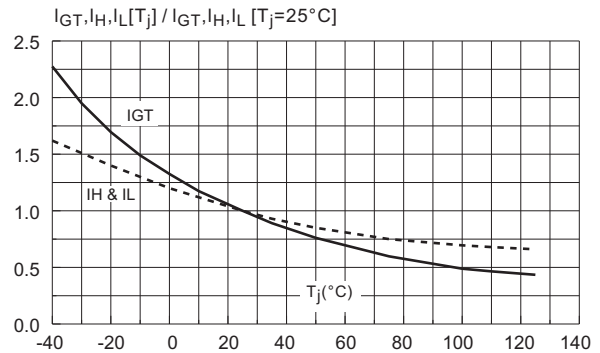


Fig.9 Relative variation of critical rate of decrease of main current versus $(dV/dt)_c$ (typical values).

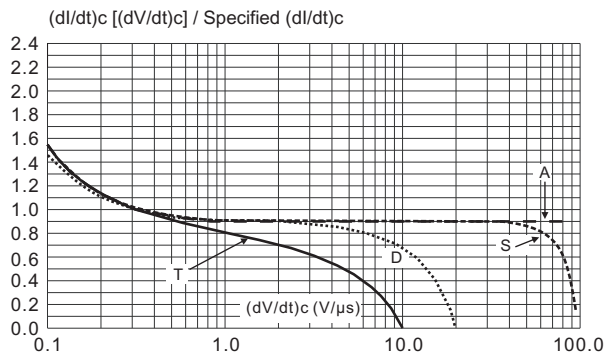


Fig.10 Relative variation of critical rate of decrease of main current versus junction temperature

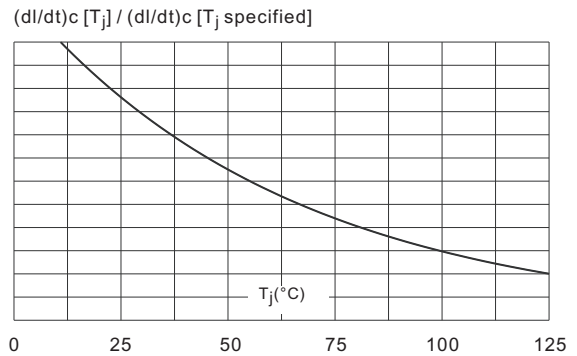
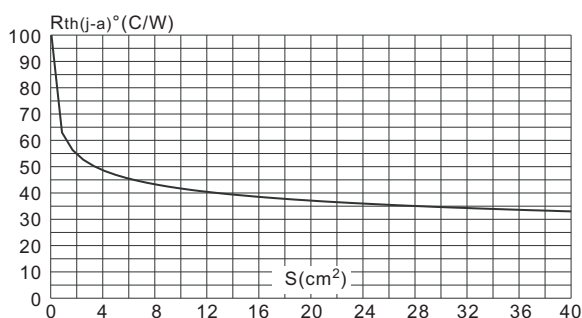
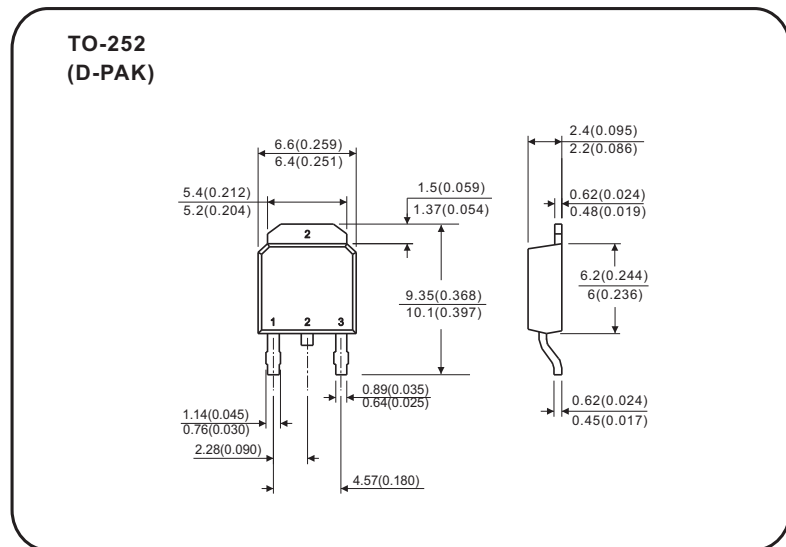
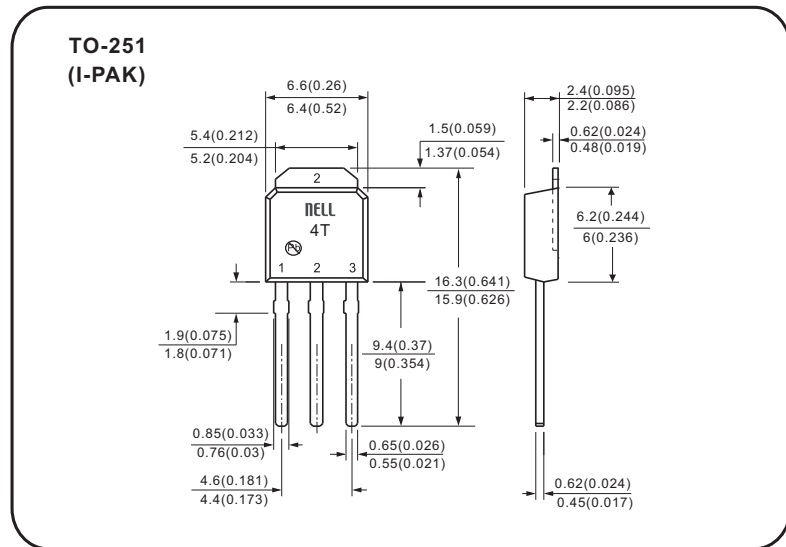
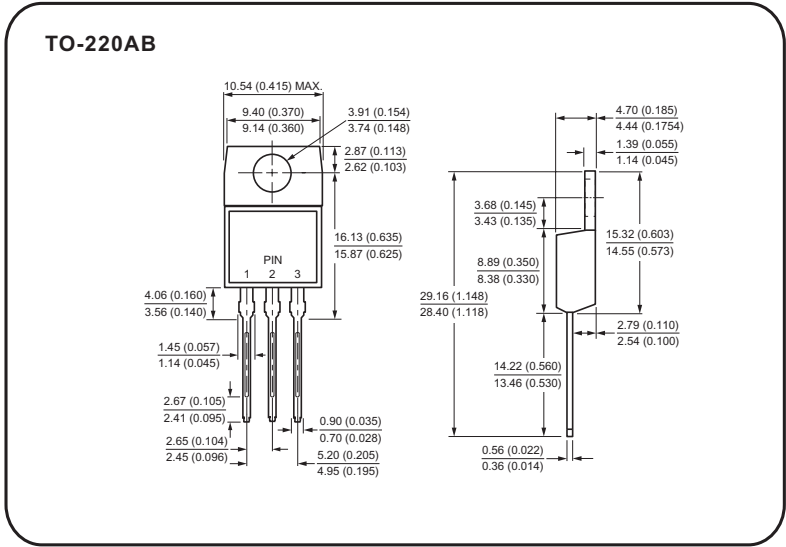


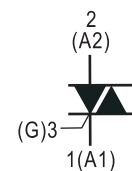
Fig.11 DPAK thermal resistance junction to ambient versus copper surface under tab (printed circuit board Fr4, copper thickness: $35 \mu\text{m}$)



Case Style



All dimensions in millimeters(inches)



Case Style

